

# AN12321

## NTAG 424 DNA (TagTamper) features and hints - LRP mode

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Application note  
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### Document information

Information	Content
Keywords	NTAG 424 DNA, NTAG 424 DNA TagTamper, Configuration, Personalization, LRP mode
Abstract	Guidelines for personalization, configuring and backend calculations of NTAG 424 DNA with focus on LRP mode



## Revision history

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Rev	Date	Description
v. 1.0	20190115	Initial version

## 1 Abbreviations

Table 1. Abbreviations

Acronym	Description
AES	Advanced Encryption Standard
AID	Application IDentifier
APDU	Application Protocol Data Unit
DF-Name	ISO7816 Dedicated File Name
C-APDU	Command APDU
CMAC	MAC according to NIST Special Publication 800-38B
CRC	Cyclic Redundancy Check
IC	Integrated Circuit
KDF	Key derivation function
LRP	Leakage resilient primitive
LSB	Lowest Significant Byte
LSb	Lowest Significant bit
MAC	Message Authentication Code
NDEF	NFC Data Exchange Format
NFC	Near Field Communication
NVM	Non-volatile memory
PCD	Proximity Coupling Device
PICC	Proximity Integrated Circuit Card
PRF	Pseudo Random Function
R-APDU	Response APDU (received from PICC)
SDM	Secure Dynamic Messaging
SSM	Standard Secure Messaging
SUN	Secure Unique NFC Messaging
UID	Unique IDentifier
URI	Uniform Resource Identifier
URL	Uniform Resource Locator

## 2 Introduction

LRP can be found:

### 2.1 About this document

This document addresses developers who are developing LRP algorithm for secure messaging on NTAG 424 DNA.

This application note is a supplementary document for implementations using the NTAG 424 DNA. This document shall be used in addition to:

- "NTAG 424 DNA - Data sheet" [\[1\]](#)
- "AN12304 Leakage Resilient Primitive (LRP) Specification" [\[2\]](#)
- "AN12196 NTAG 424 DNA and NTAG 424 DNA TagTamper features and hints" [\[3\]](#).

**Note: This application note does not replace any of the relevant functional specifications, data sheets or design guides.**

### 2.2 LRP facts

- LRP is a software protocol built on top of well-known cryptographic constructions (AES).
- LRP is a Pseudo-Random-Function (PRF). A PRF is an efficient, deterministic function that maps an input to an output.
- LRP operates on an input block size of 16 bytes, the same as for AES. LRP partially re-uses the structure of AES and also calls the AES encryption and decryption functions several times

### 2.3 Key benefits of using LRP

- LRP provides leakage resilience
- provides fault attack security
- provides side-channel attack security
- can be used as a drop-in replacement for AES

### 3 Definition of variables used in examples

The following symbols are used to abbreviate operations in the examples:

Symbol	Description
"="	Preparation of data by SAM, PICC or host
"<" or ">"	Direction of communication
	The concatenation operation
$\oplus$	exclusive-OR operation
$X \ll 1$	The bit string that results from discarding the leftmost bit of the bit string X and appending a '0' bit on the right
$0^s$	The bit string that consists of s '0' bytes
$E_{AES}(Kx, M)$	AES-128 encipher in CBC mode, IV all 0x00, using key - K of number x, M is cipher input
$D_{AES}(Kx, M)$	AES-128 decipher in CBC mode, IV all 0x00, using key - K of number x, M is cipher input
$E_{LRP}(Kx, M)$	LRP encipher using key - K of number x, M is cipher input
$D_{LRP}(Kx, M)$	LRP decipher using key - K of number x, M is cipher input
$MAC(K,M)$	Message authentication code of message M using secret key K
$MAC_t(K,M)$	Truncated message authentication code of message M using secret key K. Truncated to 8 bytes, using S14    S12    S10    S8    S6    S4    S2    S0. Even-numbered bytes shall be retained in MSB first order.
$KDF: PRF(key, message) = CMAC(Kx, message)$	A NIST recommended key derivation using pseudorandom functions. Pseudo random function: CMAC algorithm

## 3.1 Byte order

### 3.1.1 LSB representation

Represented least significant byte (LSB) first are:

- plain command parameters consisting of multiple bytes
- ISO/IEC 14443 parameters during the activation

### 3.1.2 MSB representation

Represented as most significant byte (MSB) first are:

- cryptographic parameters
- keys
- random numbers exchanged during authentication
- TI (Transaction Identifier)
- computed MACs

## 4 Example: Authentication using AuthenticateLRPFirst

In this example, an authentication using the Cmd.AuthenticateLRPFirst is executed, establishing successfully the LRP secure messaging. As mandatory action before being able to use Cmd.AuthenticateLRPFirst and so establishing the LRP secure messaging is setting the IC into LRP mode with the SetConfiguration command, as shown in [Section 5](#).

The key number which is used for the authentication is key 0x03, an application key, with the key default value.

Key Number = 0x03

Key Value = 0x00000000000000000000000000000000

**Table 2. Authentication using Cmd.AuthenticateLRPFirst**

Step	Command		Data Message
1	KeyNo	=	03
2	KeyValue	=	00000000000000000000000000000000
<b>AuthenticateLRPFirst Part 1</b>			
3	CLA	=	90
4	Ins	=	71
5	P1	=	00
6	P2	=	00
7	Lc (Length of the data)	=	08
8	Data	=	0006020000000000
9	Le (Length expected)	=	00
10	Cmd.AuthenticateLRPFirst C-APDU (Part 1)	>	9071000008000602000000000000
11	R-APDU (Part 1) = AuthMode    RndB    SW1    SW2	<	0156109A31977C855319CD4618C9D2AED291AF
12	AuthMode	=	01
13	RndB	=	56109A31977C855319CD4618C9D2AED2
14	RndA generated by PCD	=	74D7DF6A2CEC0B72B412DE0D2B1117E6
15	RndA    RndB	=	74D7DF6A2CEC0B72B412DE0D2B1117E656109A31977C855319CD4618C9D2AED2
16	Session Vector (used for session key calculation) = fixed counter    fixed length    dynamic context    fixed label	=	0001008074D7897AB6DD9C0E855319CD4618C9D2AED2B412DE0D2B1117E69669
<b>AuthenticateLRPFirst Part 2</b>			
17	Ins	=	AF
18	Data = RndA    PCDRResponse	=	74D7DF6A2CEC0B72B412DE0D2B1117E689B59DCEDC31A3D3F38EF8D4810B3B4

Step	Command		Data Message
19	PCDResponse = MAC_LRP (KSesAuthMACKey; RNDA    RNDB)	=	89B59DCEDC31A3D3F38EF8D4810B3B4
19	Cmd.AuthenticateLRPFirst C- APDU (Part 2)	>	90AF00002074D7DF6A2CEC0B72B412DE0D2B1117E6189B59DCED C31A3D3F38EF8D4810B3B400
20	R-APDU (Part 2) = PICCData    PICCResponse    SW1    SW2	<	F4FC209D9D60623588B299FA5D6B2D710125F8547D9FB8D572C90 D2C2A14E2359100
21	PICCData = Enc_LRP (KSesAuthEncKey; TI    PDCap2    PCDCap2)	=	F4FC209D9D60623588B299FA5D6B2D71
22	PICCData decrypted = Dec_LRP (KSesAuthEncKey; PICCData) with IV = EncCounter	=	58EE94240200000000002000000000
23	PICCResponse = MAC_LRP (KSesAuthMacKey; RndB    RndA    PICCData)	=	0125F8547D9FB8D572C90D2C2A14E235
24	Calculated PICCResponse == Received PICCResponse	=	Yes, correct.
25	TI	=	58EE9424
	PDcap2	=	020000000000
	PCDcap2	=	020000000000

After the authentication, the two session keys SesAuthENCKey and SesAuthMACKey can be generated. The detailed steps for generating the session keys are explained in [\[Datasheet\]](#). The session keys always consist of one key and of the related 16 secret plaintexts. In this example, the session keys have the following values:

SesAuthENCKey = {SesAuthENCUpdateKey, 16 plaintexts} with  
SesAuthENCUpdateKey = E9043D65AB21C0C422781099AB25EFDD

SesAuthMACKey = {SesAuthMACUpdateKey, 16 plaintexts} with  
SesAuthMACUpdateKey = F56CADE598CC2A3FE47E438CFEB885DB



## 5 Example: Bringing the IC into LRP Secure Messaging Mode using SetConfiguration

In this example, the IC is brought into LRP mode by using the Cmd.SetConfiguration with Option 0x05.

This is an irreversible action and permanently disables AES secure messaging, meaning LRP secure messaging is required to be used for all future sessions. Detailed process is described in [1].

**Table 3. Bringing the IC to LRP Mode by using Cmd.SetConfiguration**

Step	Command		Data Message
1	SetConfiguration Option	=	05
2	Session Encryption Key (SesAuthEncKey)	=	66A8CB93269DC9BC2885B7A91B9C697B
3	Session MAC Key (SesAuthMACKey)	=	7DE5F7E244A46D22E536804D07E8D70E
4	<b>Encrypting the Command Data</b>		
5	IV_Input (IV_Label    TI    Cmd Counter    Padding)	=	A55AED56F6E600000000000000000000
6	IV_Label	=	A55A
7	TI	=	ED56F6E6
8	Cmd Counter	=	0000
9	$E(K_{SesAuthEnc}, \text{Basis for the IV})$	=	DA0F644A4986275957CF1EC3AF4CCE53
10	IV	=	DA0F644A4986275957CF1EC3AF4CCE53
11	PDCap2.1	=	02
12	Data for Cmd.SetConfiguration	=	00000000020000000000
13	Padded Data	=	00000000020000000000800000000000
14	Encrypted Data = $E(K_{SesAuthEnc}, \text{Padded Data})$	=	41B2BA963075730426D0858D2AA6C498
15	<b>Generating the MAC for the Command APDU</b>		
16	IV for MACing	=	00000000000000000000000000000000
17	MAC_Input (Ins    Cmd Counter    TI    Cmd Header    Encrypted Data)	=	5C0000ED56F6E60541B2BA963075730426D0858D2AA6C498
18	MAC = CMAC( $K_{SesAuthMAC}$ , MAC_Input)	=	2F579E77FAB49F83
19	<b>Constructing the full Command APDU</b>		
20	CLA	=	90
21	Ins	=	5C
22	P1	=	00
23	P2	=	00

Step	Command		Data Message
24	Lc (Length of the data)	=	19
25	Data (Cmd Header    Encrypted Data    MAC)	=	0541B2BA963075730426D0858D2AA6C4982F579E77FAB49F83
26	Le (Length expected)	=	00
27	Cmd.SetConfiguration C-APDU (Cmd    Ins    P1    P2    Lc    Data    Le)	>	905C000019050041B2BA963075730426D0858D2AA6C4982F579E77FAB49F8300
28	Cmd Counter	=	0100
29	Cmd.SetConfiguration R-APDU	<	9100 (00 = SUCCESS)

## 6 Supporting tools

### 6.1 Software

Name	Description	Source
RFIDDiscover 4.5.1.8	PC software tool to evaluate NTAG 424 DNA PICC	NXP DocStore
NXPRdLib	C# API for developing Windows-based applications	NXP DocStore
TapLinX	Java-based SDK for developing Android applications, supporting all NXP RFID products, also NTAG 424 DNA	<a href="https://www.mifare.net/">https://www.mifare.net/</a>
TagInfo	Android and iOS based application to get detailed info of tapped NXP RFID products	Google PlayStore, Apple AppStore
TagWriter	Android application to configure, write NDEF data to NXP RFID products	Google PlayStore
TagXplorer	Desktop cross-platform Java application, PC/SC readers supported	<a href="https://www.nxp.com/">https://www.nxp.com/</a>
Java Lib - LRP	Java-based LRP calculation tool	Part of AN12304
Python Lib	Library written in Python	Upon request at sales representative

## 7 References

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- [1] **Data sheet** — NTAG 424 Product data sheet, doc.no. 4654\*\*<sup>[1]</sup>
- [2] **Application note** — AN12304 Leakage Resilient Primitive (LRP) Specification
- [3] **Application note** — AN12196 NTAG 424 DNA and NTAG 424 DNA TagTamper features and hints, doc.no. 5072\*\*
- [4] **Application note** — AN11350 NTAG Originality Signature Validation, doc.no. 2604\*\*

[1] \*\* ... document version number

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Tables

Tab. 1.	Abbreviations .....	3	Tab. 3.	Bringing the IC to LRP Mode by using	
Tab. 2.	Authentication	using	Cmd.SetConfiguration .....		9
	Cmd.AuthenticateLRPFirst .....	7			

## Contents

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<b>1</b>	<b>Abbreviations .....</b>	<b>3</b>
<b>2</b>	<b>Introduction .....</b>	<b>4</b>
2.1	About this document .....	4
2.2	LRP facts .....	4
2.3	Key benefits of using LRP .....	4
<b>3</b>	<b>Definition of variables used in examples .....</b>	<b>5</b>
3.1	Byte order .....	6
3.1.1	LSB representation .....	6
3.1.2	MSB representation .....	6
<b>4</b>	<b>Example: Authentication using AuthenticateLRPFirst .....</b>	<b>7</b>
<b>5</b>	<b>Example: Bringing the IC into LRP Secure Messaging Mode using SetConfiguration .....</b>	<b>9</b>
<b>6</b>	<b>Supporting tools .....</b>	<b>11</b>
6.1	Software .....	11
<b>7</b>	<b>References .....</b>	<b>12</b>
<b>8</b>	<b>Legal information .....</b>	<b>13</b>

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